

Special Issue

10th Anniversary of *Inventions*

Message from the Guest Editor

Inventions is an international, peer-reviewed, open-access scientific journal published bimonthly online by MDPI. Over the past decade, the journal has experienced significant growth in scholarly impact, manuscript submissions, published articles, and citation performance, firmly establishing itself as a high-quality archival outlet for engineering and scientific research. To celebrate the 10th Anniversary of *Inventions*, we are pleased to launch a commemorative Special Issue and invite researchers, inventors, and practitioners to submit their latest original contributions. Submissions are welcomed across a broad range of topics, including but not limited to the following:

- Advanced manufacturing technologies and processes;
- Applied chemistry and physics;
- Design methodologies, modeling, and computational approaches;
- Electrical engineering, energy systems, and communications;
- Energy systems, thermal sciences, and fluid mechanics.

Guest Editor

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Deadline for manuscript submissions

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About the Journal

Message from the Editor-in-Chief

The unique journal *Inventions* is different from all other journals. Many scholars spend their lives publishing research papers in many different journals, but most of these journals do not help scholars collate and analyze their results or assist in promoting them to a relevant industry. However, *Inventions* will help authors not only to publish their papers in the journal, but also to promote their research results to industry and assist them in realizing the purpose of technology transfer. In the future, *Inventions* will help authors to evaluate their technology license fees based on the valuation theory and approaches and also help authors to show their patents and technologies on a network transaction platform.

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